

# Sub-5 nm Patterning Using Helium Ion Beam Lithography and Nanoimprint Lithography

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## Goal: Deterministic patterning of sub-5 nm features

EBL doesn't have enough resolution.

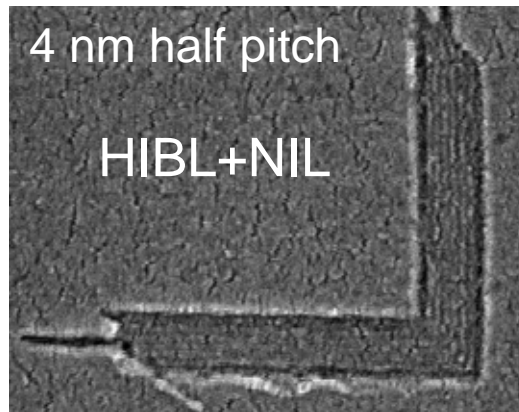
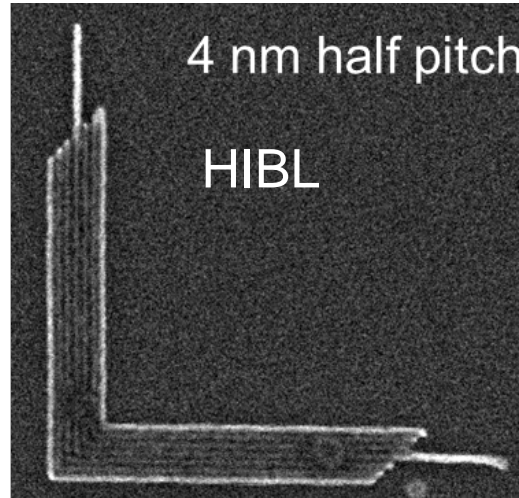
Helium ion beam lithography(HIBL)

- Better resolution than EBL
  - Smaller focus spot
  - Less proximity effects
- Slow
- Damage certain substrates

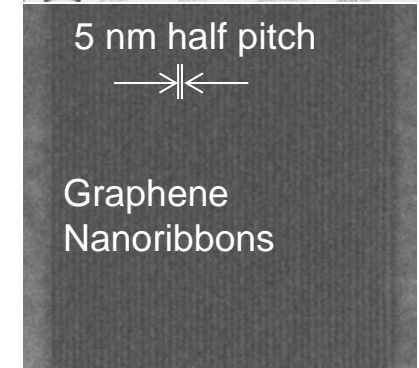
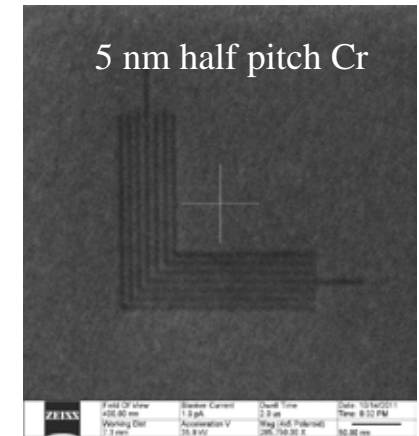
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Nanoimprint lithography(NIL)

- High throughput
- Work on arbitrary substrates
- Needs mold



Direct milling with He<sup>+</sup>



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